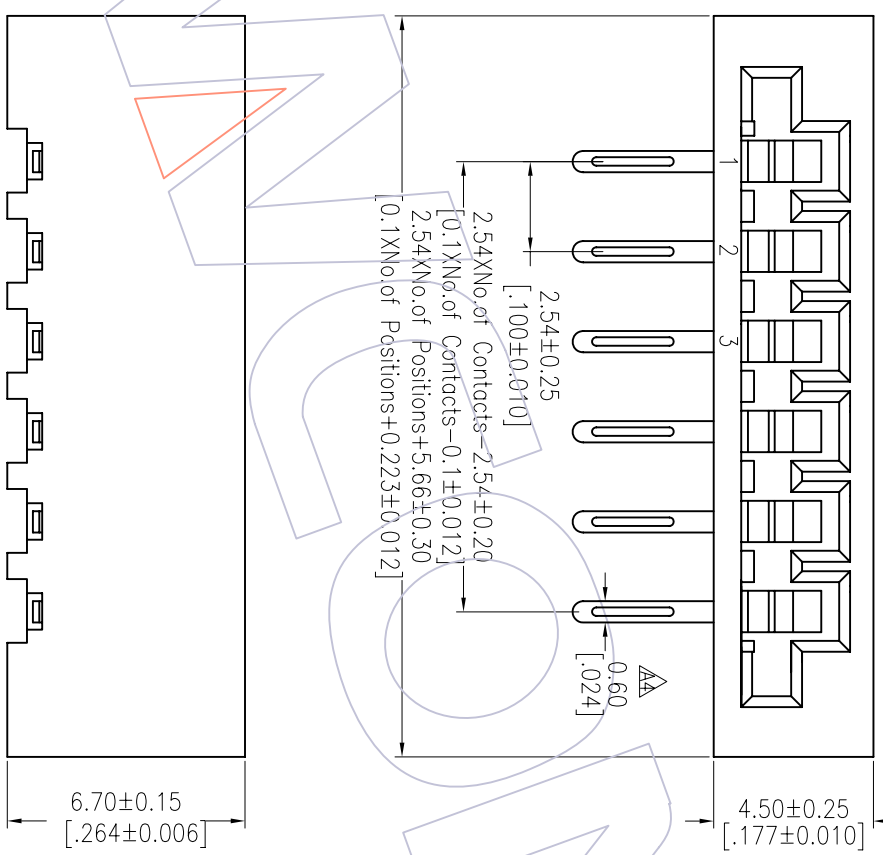
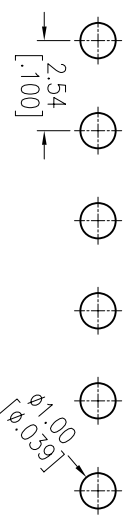


# HSF

**NOTES:**

Rated Current:1.0AMP  
 Contact Resistance:30mΩ max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ min  
 Operation Temperature:-55°C to +85°C  
 Contact Material:Phosphor Bronze  
 Contact Plating:Sn Over Ni  
 Insulator Material:Thermoplastic UL94V-0

Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



## Ordering Information

5110-XX R R D N X T01

No. of Pins  
03-27P

Color  
A=Brown  
B=Black  
W=White  
E=Beige

A4	11/11/17	3.00 → 3.20 4.55 → 4.50 0.65 → 0.60
A3	11/02/22	图面与产品不符:塑胶上是致缺口,而图面上就有缺口
A2	10/12/02	5110-XXRDDNX01 → 5110-XXRDDXT01
A1	09/08/11	3.20 → 3.00
REV	DATE	MODIFICATION DESCRIPTION

OPERATION	X.X	±0.40	DRAW	MWQ	11/11/17	SCALE	FIT
	X.XX	±0.25					
Angle	X.XXX	±0.15	CHECK	APPROVE		SHEET	1/1
	Angle	± 3°					
DIM	TOL	APPROVE	PROJ.				

**WCON** 维峰五金电子有限公司  
 WAFER HARDWARE ELECTRONICS CO. LTD

PART NO.	5110-XXRDDNXT01
TITLE:	2.54 FPC 90° DIP DUAL CONTACT W/O LOCK
CUSTOMER NO.	